

C0805C181J5RACTU

Aliases (C0805C181J5RAC7800) SMD Comm X7R, Ceramic, 180 pF, 5%, 50 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 0805, 0.7 mm



General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	11 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	0.78mm +/-0.10mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

VV	1.25mm +/-0.2mm
Т	0.78mm +/-0.10mm
S	0.7mm MIN
В	0.5mm +/-0.25mm
Packaging Specifications	

4000

T&R, 180mm, Paper Tape

Packaging

Packaging Quantity

Specifications	
Capacitance	180 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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